COMPARISON OF 2 V ORGANIC THIN-FILM TRANSISTORS FABRICATED ON FREE-STANDING COMMERCIAL PEN FOILS

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> INTRODUCTION

Large-area, roll-to-roll (R2R) fabrication of thin-film circuits on plastic foils demands low-cost manufacturing and the integration of devices onto flexible plastic substrates. We have developed a fully dry process to fabricate low-voltage organic thin-film transistors (OTFTs) featuring a 10-nm-thick bi-layer dielectric based on aluminium oxide (AlO_x) and n-octylphosphonic acid (C_8PA) monolayer. Two commercially available polyethylene naphthalate (PEN) plastic foils were compared as possible flexible substrates for OTFTs. Teonex Q65FA features an adhesive layer on the bottom side to prevent film slippage during R2R processing, while Optfine PQA1 includes a planarisation layer on the top (device) side.

\succ AIMS

- Study the effect of annealing at 160°C on bare Teonex and Optfine PEN foils .
- Fabricate low-voltage OTFTs on both substrates.
- Compare Al/AlO_x/C₈PA/DNTT/Au and Al/AlO_x/DNTT/Au transistors and metal-insulator-metal (MIM) structures fabricated on each PEN foil.

EXPERIMENT

• Teonex and Optfine PEN films were pre-annealed at 160°C for 24 hours prior to OTFT fabrication.

> ANNEAL: OPTFINE SUBSTRATE

Prior to anneal

24-hour anneal at 160°C

Subsequently, Al/AlO_x/C₈PA/DNTT/Au and Al/AlO_x/DNTT/Au OTFTs were fabricated on non-annealed Optfine and pre-annealed Teonex foils.



Radius of curvature ~ 17 cm

Radius of curvature ~ 1.5 cm



- 15 nm of DNTT was deposited at room temperature at rates of 0.4 Å/s and 0.6 Å/s on Teonex and Optfine respectively. \bullet
- AIO_x prepared by UV/ozone oxidation of aluminium.
- All other layers are thermally evaporated in Minispectros vacuum system (K.J. Lesker).

Linear regime $(|V_{DS}| < |V_{GS} - V_t|)$: $I_{\rm D} = \mu C \frac{W}{L} (V_{\rm GS} - V_{\rm t}) V_{\rm DS}$ $\mu_{\rm lin} = \frac{\partial I_{\rm D}}{\partial V_{\rm GS}} \cdot \frac{1}{CV_{\rm DS} \frac{W}{L}}$

Saturation regime $(|V_{DS}| > |V_{GS}-V_t|)$: $I_{\rm D} = \mu C \frac{W}{2L} (V_{\rm GS} - V_{\rm t})^2$ $\mu_{\text{sat}} = \left(\frac{\partial \sqrt{I_{\text{D}}}}{\partial V_{\text{GS}}}\right)^2 \cdot \frac{1}{C\frac{W}{2L}}$







RESULTS: GATE DIELECTRIC

	Teone	x Q65FA	Optfine PQA1		
	AlO _x	AIO _x /C ₈ PA	AIO _x	AIO _x /C ₈ PA	
Capacitance (μF/cm²)	0.74	0.66	0.86	0.43	
Current @ -2 V (A/cm²)	rrent @ -2 V 4.42x10 ⁻⁷ (A/cm ²)		2.32x10 ⁻⁷	8.39x10 ⁻⁸	

RESULTS: TRANSISTORS



RESULTS: BIAS STRESS

- Performed on 4 transistors: Teonex Q65FA bare-AlO_x OTFT, Teonex Q65FA AlO_x/C₈PA OTFT, Optfine PQA1 – bare-AlO_x OTFT, and Optfine PQA1 – AlO_x/C₈PA OTFT.
- Bias stress performed about 1 week after the initial measurements shown on the left were taken.
- Bias stress up to 1000 seconds with $V_{GS} = -2$ V, whilst grounding the source and drain electrodes.
- At certain intervals, transfer characteristics were measured to determine OTFT parameters including V_{t} , μ , S, I_{OFF} and I_{ON} .

	Teonex Q65FA				Optfine PQA1			
	AIO _x OTFT bias stress		AIO _x /C ₈ PA OTFT bias stress		AlO _x OTFT bias stress		AIO _x /C ₈ PA OTFT bias stress	
	0 s	1000 s	0 s	1000 s	0 s	1000 s	0 s	1000 s
<i>V</i> _t (V)	-1.20	-1.75	-1.27	-1.70	- 0.40	-1.58	- 0.72	-1.33
μ (cm²/Vs)	0.090	0.079	0.11	0.088	0.018	0.022	0.16	0.16
<i>S</i> (mV/dec)	85	68	78	74	166	111	112	103
<i>I</i> _{OFF} (A)	1.4x10 ⁻¹¹	1.3x10 ⁻¹²	1.8x10 ⁻¹²	1.1x10 ⁻¹²	2.8x10 ⁻¹⁰	1.2x10 ⁻¹¹	1.7x10 ⁻¹¹	6.5x10 ⁻¹²
<i>I</i> _{on} (A)	3.6x10 ⁻⁷	3.3x10 ⁻⁸	3.2x10 ⁻⁷	4.6x10 ⁻⁸	4.0x10 ⁻⁷	3.9x10 ⁻⁸	9.9x10 ⁻⁷	4.0x10 ⁻⁷



CONCLUSIONS

- Teonex PEN is easier to handle, since it remained flat upon heating at 160°C.
- Optfine PEN curves significantly upon heating and presents a substantial challenge if used as a free-standing substrate with our OTFT fabrication procedure.
- Planarisation layer on Optfine PEN results in about a factor of three greater field-effect mobility for AIO_x/C₈PA OTFTs compared with Teonex PEN.
- OTFTs on Optfine PEN appear to remain more stable after application of bias stress in terms of mobility compared with OTFTs on Teonex PEN.



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